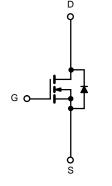


AUFU4104-VB Datasheet N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{a, c}	Q _g (Typ.)			
40	0.0016 at V _{GS} = 10 V	120	120 nC			
	0.0020 at V _{GS} = 4.5 V	100	120110			
	D					



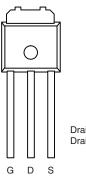
FEATURES

- Trench Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

- Synchronous Rectification
- Power Supplies





Top View

TO-251



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V	semive6688	40	N	
Gate-Source Voltage		V _{GS}	± 25	V	
	T _C = 25 °C		120 ^{a, c}		
Continuous Drain Current (T $= 175 ^{\circ}\text{C}$)	T _C = 70 °C		96 ^c		
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	I _D	29 ^b	A	
	T _A = 70 °C		23 ^b	A	
Pulsed Drain Current	I _{DM}	250	7		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	96		
Single Pulse Avalanche Energy		E _{AS}	320	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C		120 ^{a, c}	^	
Continuous Source-Drain Diode Current	T _A = 25 °C	ا ا _S	2.6 ^b	- A	
	T _C = 25 °C		312 ^a		
Mauiauna Daura Diasia stian	T _C = 70 °C	P _D	200	14/	
Maximum Power Dissipation	T _A = 25 °C		3.13 ^b	W	
	T _A = 70 °C		2.0 ^b		
Operating Junction and Storage Temperature Ra	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.33	0.4	C/W	

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 120 A.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	·			·			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		41		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	ι <u>β</u> = 200 μΛ		- 8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	1	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 40 V, V _{GS} = 0 V, T _J = 55 °C			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	120			Α	
	P	V _{GS} = 10 V, I _D = 30 A		0.0016		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0020			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A		180		S	
Dynamic ^b							
Input Capacitance	C _{iss}			9000		pF	
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		650			
Reverse Transfer Capacitance	C _{rss}			450			
Total Gate Charge	Qg			120	180	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		30			
Gate-Drain Charge	Q _{gd}			16			
Gate Resistance	R _g	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 20 V, R_L = 1.0 Ω		11	17	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 20 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		77	115		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			102	155	ns	
Rise Time	t _r	V_{DD} = 20 V, R_L = 1.0 Ω		62	95	1	
Turn-Off Delay Time	$t_{d(off)}$ $I_D \cong 20$ Å, $V_{GEN} = 4.5$ V, $R_g =$			180	270		
Fall Time	t _f			60	90	1	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			110		
Pulse Diode Forward Current ^a	I _{SM}				200	A	
Body Diode Voltage	V _{SD}	I _S = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			50	75	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			70	105	nC	
Reverse Recovery Fall Time	t _a	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, \text{T}_J = 25 \text{ °C}$		30			
Reverse Recovery Rise Time	t _b			20		ns	

Notes:

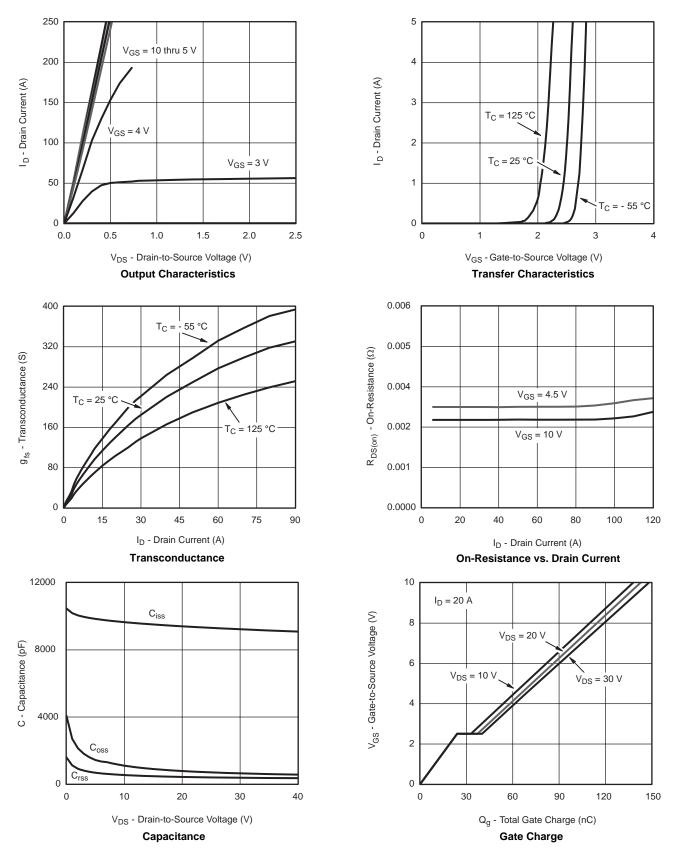
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



服务热线:400-655-8788

2.0



1.2

150

I_D = 30 A 1.7 10 $V_{GS} = 10 V$ R_{DS(on)} - On-Resistance I_S - Source Current (A) T_J = 150 °C T_J = 25 °C (Normalized) 1.4 1 $V_{GS} = 4.5 V$ 1.1 0.1 0.8 0.01 0.5 0.001 . 0.0 0.2 0.4 0.6 0.8 1.0 - 50 - 25 0 25 50 75 100 125 150 V_{SD} - Source-to-Drain Voltage (V) T_J - Junction Temperature (°C) **On-Resistance vs. Junction Temperature** Forward Diode Voltage vs. Temperature 0.010 0.6 0.008 R $_{DS(on)}$ - On-Resistance (Ω) 0.2 V_{GS(th)} Variance (V) 0.006 - 0.2 $I_D = 5 \text{ mA}$ 0.004 T_J = 150 °C - 0.6 0.002 I_D = 250 μA T_J = 25 °C 0.000 - 1.0 2 4 6 8 10 - 50 - 25 0 25 50 75 100 125 0 T_J - Temperature (°C) V_{GS} - Gate-to-Source Voltage (V) **Threshold Voltage On-Resistance vs. Gate-to-Source Voltage** 1000 TTT Limited by R_{DS(on)}* 1-1 10 µs 100 100 µs ŦĦ I_D - Drain Current (A) 1 ms -10 10 ms 100 ms, DC 1 $T_C = 25 °C$ 0.1 Single Pulse BVDSS ≣ 111 0.01 0.1 1 10 100 V_{DS} - Drain-to-Source Voltage (V)

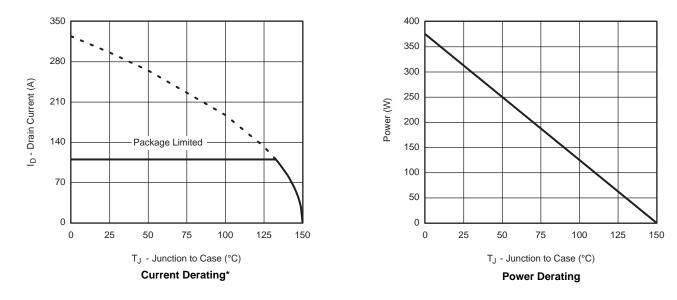
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified Safe Operating Area, Junction-to-Ambient

100

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

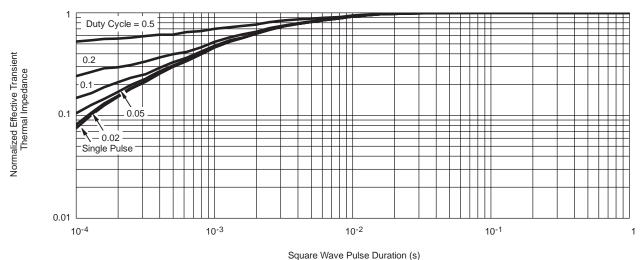






TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

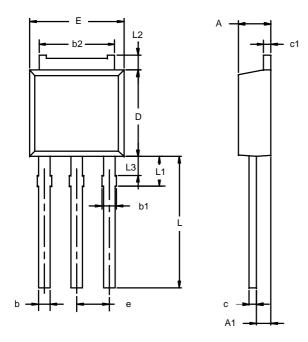
* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA



	MILLIN	IETERS	INCHES		
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
E	6.48	6.73	0.255	0.265	
е	2.28	BSC	0.090	BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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